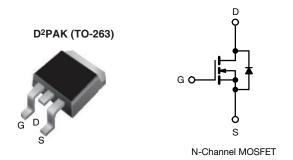
HALOGEN

FREE

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## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.54				
Q <sub>g</sub> max. (nC)	8.3				
Q <sub>gs</sub> (nC)	2.3				
Q <sub>gd</sub> (nC)	3.8				
Configuration	Single				



#### **FEATURES**

- Surface mount
- · Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- · Fast switching
- · Ease of paralleling
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D2PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SiHF510S-GE3	SiHF510STRL-GE3 <sup>a</sup>	SiHF510STRR-GE3 a			
Load (Dh) fron	IRF510SPbF	IRF510STRLPbF a	IRF510STRRPbF <sup>a</sup>			
Lead (Pb)-free	SiHF510S-E3	SiHF510STL-E3 a	SiHF510STR-E3 a			

#### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	100	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	1	5.6		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	4.0	Α	
Pulsed Drain Current a			I <sub>DM</sub>	20		
Linear Derating Factor				0.29	W/°C	
Linear Derating Factor (PCB mount) e				0.025	VV/ C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	75	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.6	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.3	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			P <sub>D</sub>	43	w	
Maximum Power Dissipation (PCB mount) e T <sub>A</sub> = 25 °C				3.7	] vv	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering Recommendations (Peak temperature) d for 10 s			<u> </u>	300	7	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 4.8 \,\text{mH}$ ,  $R_g = 25 \,^{\circ}\text{C}$ ,  $I_{AS} = 5.6 \,\text{A}$  (see fig. 12). c.  $I_{SD} \leq 5.6 \,\text{A}$ ,  $I_{AS} = 5.6 \,\text{A}$ ,  $I_{AS} = 5.6 \,\text{A}$  (see fig. 12).
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

Document Number: 91016



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5			

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	,
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	100		-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 20 \text{ V}$	-		± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		: 100 V, V <sub>GS</sub> = 0 V	-	-	25	μA
			$V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$	-	-	250	F
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3.4 \text{ A}^{\text{ b}}$	-	-	0.54	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 3.4 A <sup>b</sup>	1.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	180	-	
Output Capacitance	Coss		$V_{DS} = 25 \text{ V},$	-	81	-	рF
Reverse Transfer Capacitance	$C_{rss}$	t = 1.	f = 1.0 MHz, see fig. 5		15	-	
Total Gate Charge	$Q_g$			-	-	8.3	nC
Gate-Source Charge	$Q_gs$	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_{D} = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and fig. 13 b		-	2.3	
Gate-Drain Charge	$Q_{gd}$				-	3.8	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 50 \text{ V}, I_D = 5.6 \text{ A},$ $R_g = 24 \Omega, R_D = 8.4 \Omega, \text{ see fig. } 10^{\text{ b}}$		-	6.9	-	- ns
Rise Time	t <sub>r</sub>			-	16	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	9.4	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	الم
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	5.6	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	20	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 5.6 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = 5.6 \text{A},  \text{dI/dt} = 100 \text{A/µs}^{\text{b}}$		-	100	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.44	0.88	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	on is dor	ninated b	v L <sub>s</sub> and	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

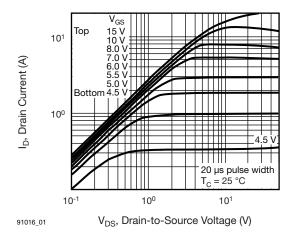


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

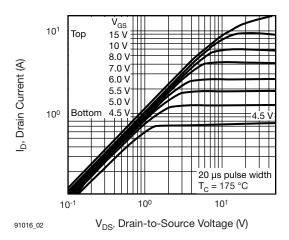


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

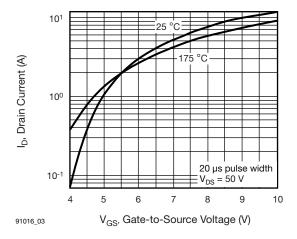


Fig. 3 - Typical Transfer Characteristics

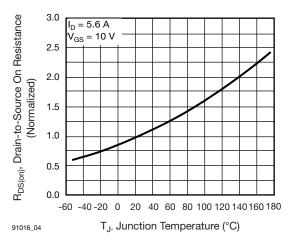


Fig. 4 - Normalized On-Resistance vs. Temperature

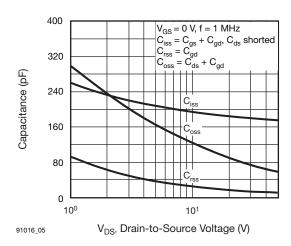


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

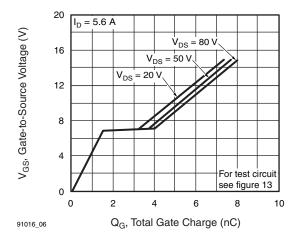


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



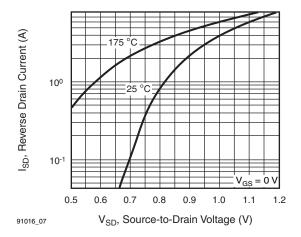


Fig. 7 - Typical Source-Drain Diode Forward Voltage

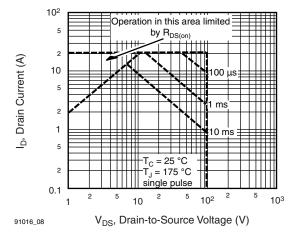


Fig. 8 - Maximum Safe Operating Area

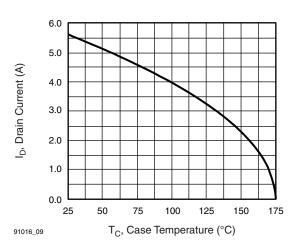


Fig. 9 - Maximum Drain Current vs. Case Temperature

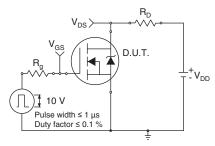


Fig. 10a - Switching Time Test Circuit

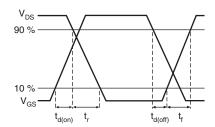


Fig. 10b - Switching Time Waveforms

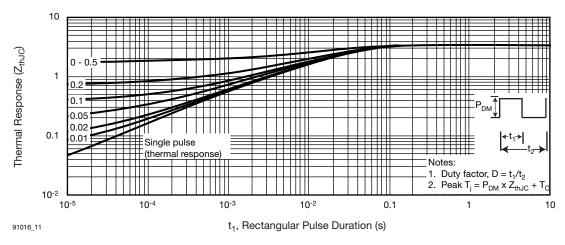


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



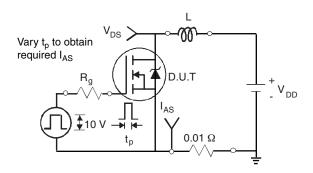


Fig. 12a - Unclamped Inductive Test Circuit

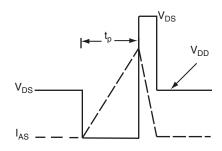


Fig. 12b - Unclamped Inductive Waveforms

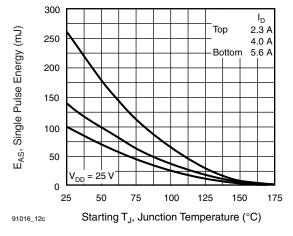


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

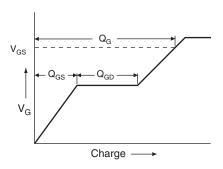


Fig. 13a - Basic Gate Charge Waveform

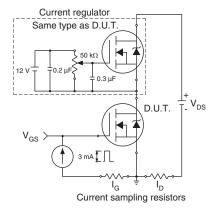
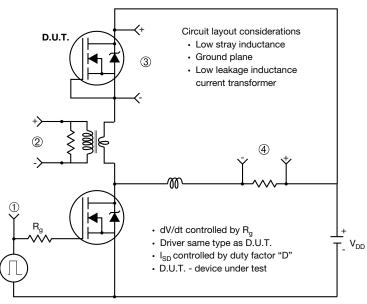


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



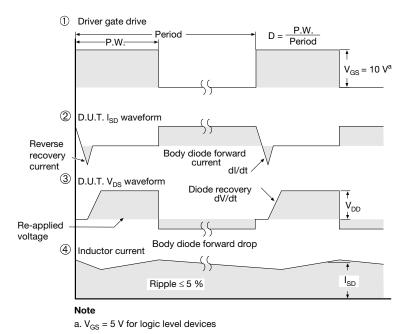


Fig. 14 - For N-Channel

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### **TO-263AB (HIGH VOLTAGE)**







]	+		D1	4
	-E1-	<b>₩</b>	<u> </u>	7

	MILLIN	METERS	INC	HES
DIM.	MIN. MAX.		MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIN	METERS	INC	HES	
DIM.	MIN. MAX.		MIN.	MAX.	
D1	6.86	-	0.270	-	
Е	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	i	
е	2.54	BSC	0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	i	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### DWG: 5970 Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).

ECN: S-82110-Rev. A, 15-Sep-08

- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08



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